Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

05/20/2022

Details for "TPS54615PWPG4"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TPS54615PWPG4	NIPDAU	Level-2-260C-1 YFAR	TI TAIWAN A/T	PWP 28	4.4x9.7x1.15	112.9

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

		Homogeneous Material Leve		neous Material Level	vel Component Level		
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Aluminum and Its Alloys	Aluminum	7429-90-5	0.000001	0.000113	1	0.000001	0
Copper and Its Alloys	Copper	7440-50-8	0.881378	99.997277	999973	0.780981	7810
Copper and Its Alloys	Iron	7439-89-6	0.000004	0.000454	5	0.000004	0
Other Inorganic Materials	Sulfur	7704-34-9	0.000001	0.000113	1	0.000001	0
Other Nonferrous Metals and Alloys	Calcium	7440-70-2	0.000003	0.00034	3	0.000003	0
Precious Metals	Silver	7440-22-4	0.000015	0.001702	17	0.000013	0
Sub-Total			0.881402	100	1000000	0.781002	7810
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	1.078001	70.000019	700000	0.955206	9552
Thermoplastics	Ероху	85954-11-6	0.462	29.999981	300000	0.409374	4094
Sub-Total			1.540001	100	1000000	1.36458	13646
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	41.30184	97.41	974100	36.597163	365972
Copper and Its Alloys	Iron	7439-89-6	1.0176	2.4	24000	0.901686	9017
Copper and Its Alloys	Phosphorus	7723-14-0	0.01272	0.03	300	0.011271	113
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.01272	0.03	300	0.011271	113
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.01272	0.03	300	0.011271	113
Zinc and Its Alloys	Zinc	7440-66-6	0.0424	0.1	1000	0.03757	376
Sub-Total			42.4	100	1000000	37.570232	375702
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.722912	95.12	951200	0.640565	6406
Precious Metals	Gold	7440-57-5	0.005928	0.78	7800	0.005253	53
Precious Metals	Palladium	7440-05-3	0.03116	4.1	41000	0.027611	276
Sub-Total			0.76	100	1000000	0.673429	6734
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	51.762294	85.000002	850000	45.866071	458661
Other Nonferrous Metals and Alloys	Metal Oxide	Trade Secret	0.730762	1.2	12000	0.647521	6475
Other Plastics and Rubber	Carbon Black	1333-86-4	0.18269	0.299999	3000	0.16188	1619
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.18269	0.299999	3000	0.16188	1619
Other Plastics and Rubber	Silicone	218163-11-2	1.826904	2.999999	30000	1.618802	16188
Thermoplastics	Epoxy	85954-11-6	6.211475	10.2	102000	5.503928	55039
Sub-Total			60.896815	100	1000000	53.960082	539601
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	6.377087	100	1000000	5.650675	56507
Sub-Total			6.377087	100	1000000	5.650675	56507
Total			112.855305			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

Important Part Information

See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Ti and TI suppliers may consider certain information to be proprietary, and two certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/20/2022

ROHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, Ti semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. Ti may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the ROHS Annex II threshold, but that fall within one of the specific ROHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet 15709B low halogen requirements of <= 1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.